



STB95N3LLH6, STD95N3LLH6 STP95N3LLH6, STU95N3LLH6

N-channel 30 V, 0.0037 Ω , 80 A, D²PAK, DPAK, IPAK, TO-220
STripFET™ VI DeepGATE™ Power MOSFET

Features

Type	V _{DSS}	R _{DS(on)} max	I _D
STB95N3LLH6	30 V	0.0042 Ω	80 A
STD95N3LLH6	30 V	0.0042 Ω	80 A
STP95N3LLH6	30 V	0.0042 Ω	80 A
STU95N3LLH6	30 V	0.0047 Ω	80 A

- R_{DS(on)} * Q_g industry benchmark
- Extremely low on-resistance R_{DS(on)}
- High avalanche ruggedness
- Low gate drive power losses

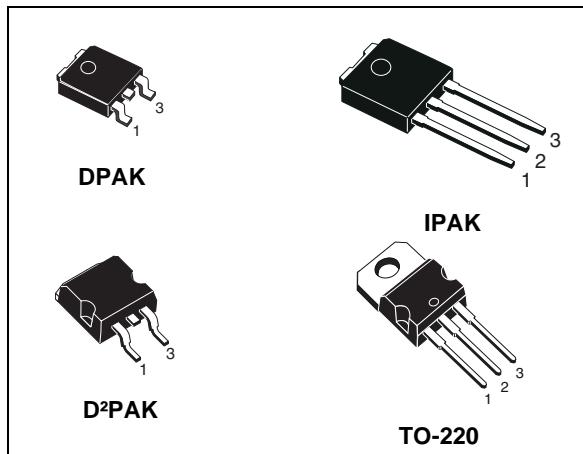
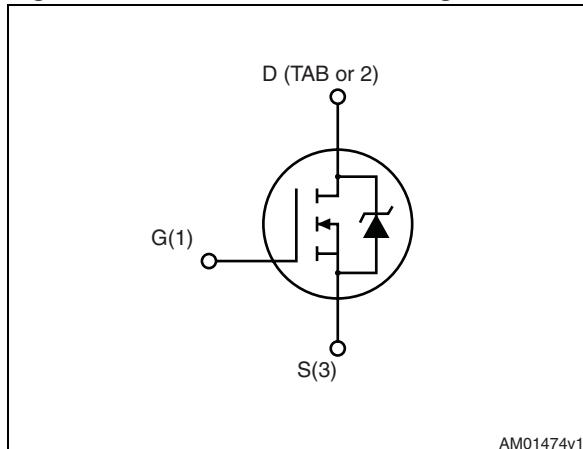


Figure 1. Internal schematic diagram



AM01474v1

Table 1. Device summary

Order codes	Marking	Package	Packaging
STB95N3LLH6	95N3LLH6	D ² PAK	Tape and reel
STD95N3LLH6	95N3LLH6	DPAK	Tape and reel
STP95N3LLH6	95N3LLH6	TO-220	Tube
STU95N3LLH6	95N3LLH6	IPAK	Tube

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1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{DS}	Drain-source voltage ($V_{GS} = 0$)	30	V
V_{GS}	Gate-source voltage	± 20	V
$I_D^{(1)}$	Drain current (continuous) at $T_C = 25^\circ\text{C}$	80	A
I_D	Drain current (continuous) at $T_C = 100^\circ\text{C}$	61	A
$I_{DM}^{(2)}$	Drain current (pulsed)	320	A
P_{TOT}	Total dissipation at $T_C = 25^\circ\text{C}$	70	W
	Derating factor	0.47	W/ $^\circ\text{C}$
$E_{AS}^{(3)}$	Single pulse avalanche energy	150	mJ
T_{stg}	Storage temperature	-55 to 175	$^\circ\text{C}$
T_j	Max. operating junction temperature	175	$^\circ\text{C}$

1. Limited by wire bonding
2. Pulse width limited by safe operating area
3. Starting $T_j = 25^\circ\text{C}$, $I_{AV} = 55 \text{ A}$, $L = 0.1 \text{ mH}$

Table 3. Thermal data

Symbol	Parameter	Value				Unit
		D ² PAK	DPAK	IPAK	TO-220	
$R_{thj-case}$	Thermal resistance junction-case max	2.14		$^\circ\text{C/W}$		
$R_{thj-amb}$	Thermal resistance junction-ambient max		100		62.5	$^\circ\text{C/W}$
$R_{thj-pcb}^{(1)}$	Thermal resistance junction-pcb max	35	35			$^\circ\text{C/W}$
T_I	Maximum lead temperature for soldering purpose	275		300		$^\circ\text{C}$

1. When mounted on FR-4 board of 1 inch², 2 oz Cu.

2 Electrical characteristics

($T_{CASE} = 25^\circ\text{C}$ unless otherwise specified)

Table 4. Static

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown Voltage	$I_D = 250 \mu\text{A}, V_{GS} = 0$	30			V
I_{DSS}	Zero gate voltage drain current ($V_{GS} = 0$)	$V_{DS} = 30 \text{ V}$ $V_{DS} = 30 \text{ V}, T_c = 125^\circ\text{C}$			1 10	μA μA
I_{GSS}	Gate body leakage current ($V_{DS} = 0$)	$V_{GS} = \pm 20 \text{ V}$			± 100	nA
$V_{GS(\text{th})}$	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	1		2.5	V
$R_{DS(on)}$	Static drain-source on resistance	$V_{GS} = 10 \text{ V}, I_D = 40 \text{ A}$ SMD version		0.0037	0.0042	Ω
		$V_{GS} = 10 \text{ V}, I_D = 40 \text{ A}$		0.0042	0.0047	Ω
		$V_{GS} = 4.5 \text{ V}, I_D = 40 \text{ A}$ SMD version		0.0055	0.007	Ω
		$V_{GS} = 4.5 \text{ V}, I_D = 40 \text{ A}$		0.006	0.0075	Ω

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min	Typ.	Max.	Unit
C_{iss}	Input capacitance			2200		pF
C_{oss}	Output capacitance	$V_{DS} = 25 \text{ V}, f=1 \text{ MHz}$, $V_{GS} = 0$	-	400	-	pF
C_{rss}	Reverse transfer capacitance			280		pF
Q_g	Total gate charge	$V_{DD} = 15 \text{ V}, I_D = 80 \text{ A}$		20		nC
Q_{gs}	Gate-source charge	$V_{GS} = 4.5 \text{ V}$	-	8.2	-	nC
Q_{gd}	Gate-drain charge	<i>Figure 13</i>		7.5		nC
Q_{gs1}	Pre V_{th} gate-to-source charge	$V_{DD} = 15 \text{ V}, I_D = 80 \text{ A}$		3.4		nC
Q_{gs2}	Post V_{th} gate-to-source charge	<i>Figure 18</i>	-	6.2		nC
R_G	Gate input resistance	$f = 1 \text{ MHz}$ gate bias Bias = 0 test signal level = 20 mV open drain	-	1	-	Ω

Table 6. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$ t_r	Turn-on delay time Rise time	$V_{DD} = 15 \text{ V}$, $I_D = 40 \text{ A}$, $R_G = 4.7 \Omega$, $V_{GS} = 5 \text{ V}$ <i>Figure 12</i>	-	19 91	-	ns ns
$t_{d(off)}$ t_f	Turn-off delay time Fall time	$V_{DD} = 15 \text{ V}$, $I_D = 40 \text{ A}$, $R_G = 4.7 \Omega$, $V_{GS} = 5 \text{ V}$ <i>Figure 12</i>	-	24.5 23.4	-	ns ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
I_{SD} $I_{SDM}^{(1)}$	Source-drain current Source-drain current (pulsed)		-		80 320	A A
$V_{SD}^{(2)}$	Forward on voltage	$I_{SD} = 40 \text{ A}$, $V_{GS} = 0$	-		1.1	V
t_{rr} Q_{rr} I_{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD} = 80 \text{ A}$, $dI/dt = 100 \text{ A}/\mu\text{s}$, $V_{DD} = 24 \text{ V}$ <i>Figure 14</i>	-	28.6 22.8 1.6		ns nC A

1. Pulse width limited by safe operating area
2. Pulsed: pulse duration = 300 μs , duty cycle 1.5%

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

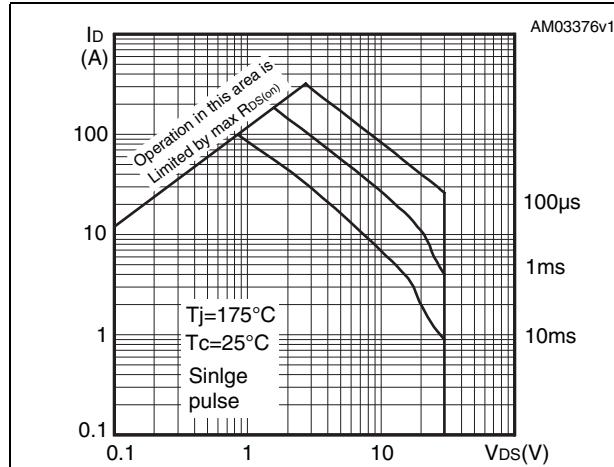


Figure 3. Thermal impedance

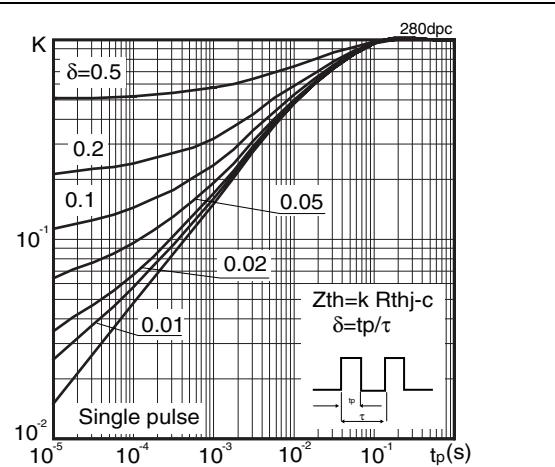


Figure 4. Output characteristics

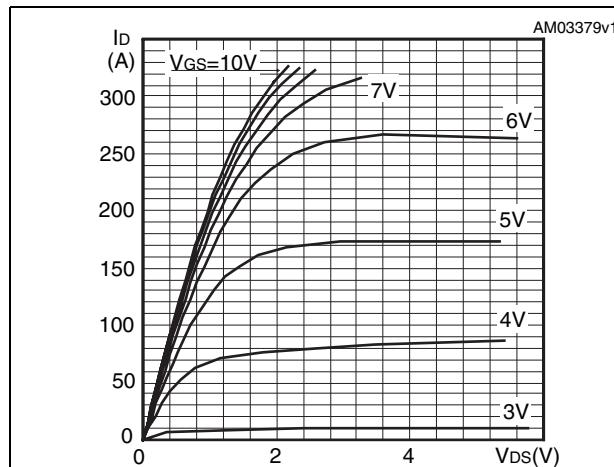


Figure 5. Transfer characteristics

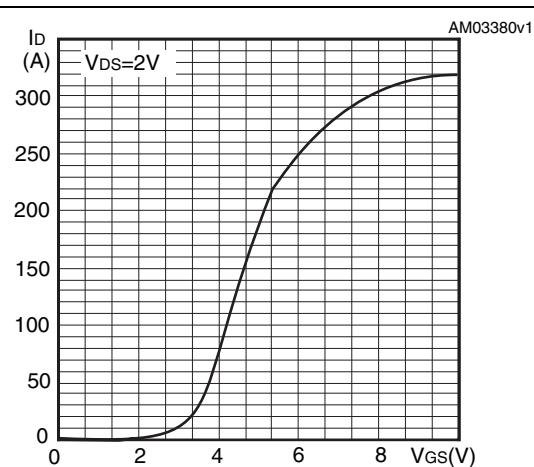
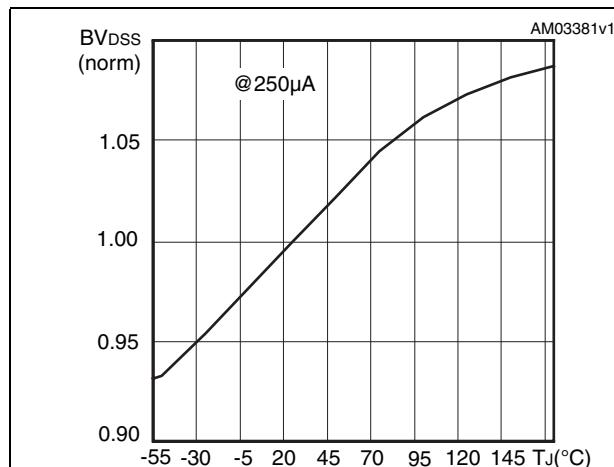
Figure 6. Normalized BV_{DSS} vs temperature

Figure 7. Static drain source on resistance

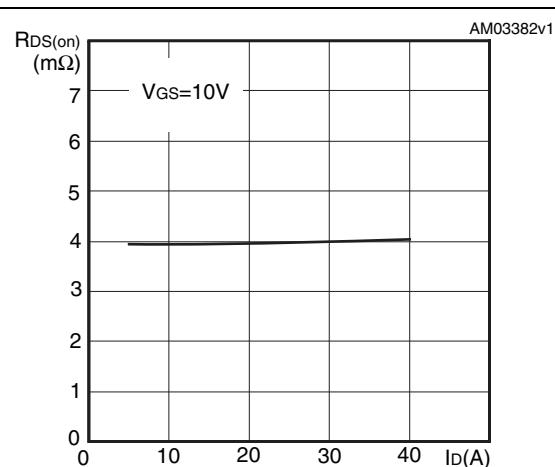
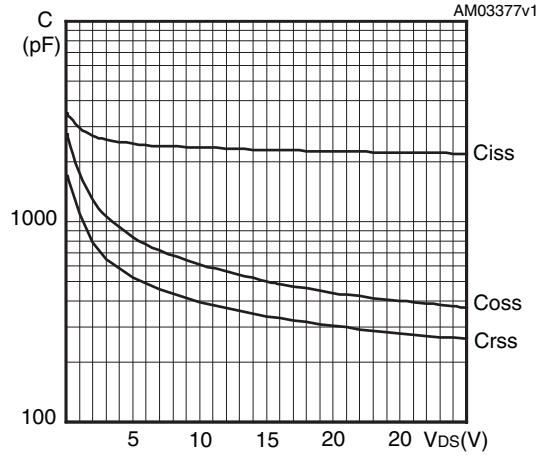
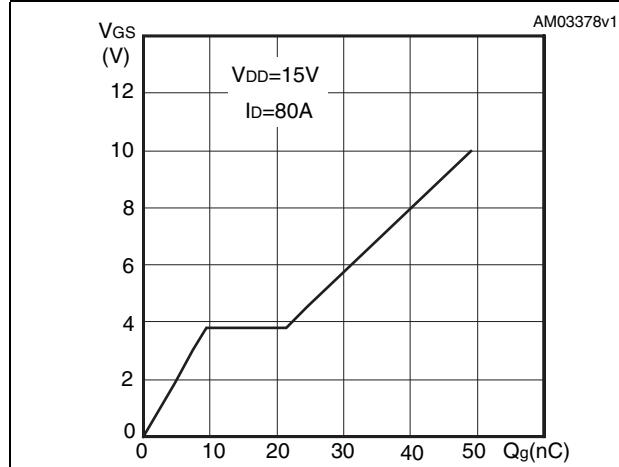
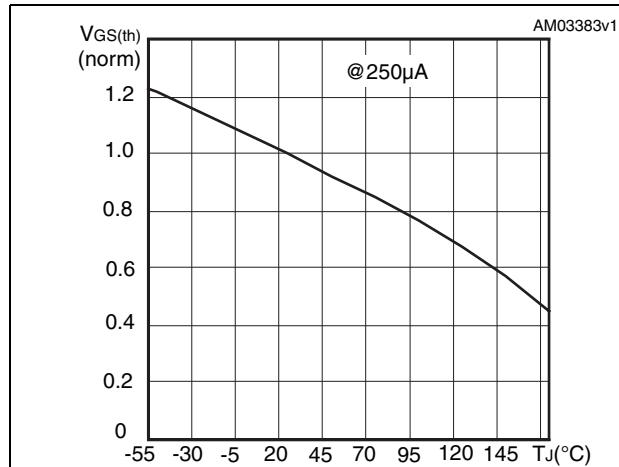
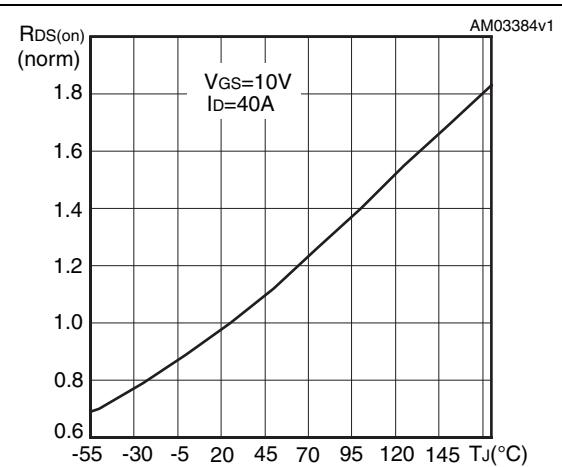


Figure 8. Gate charge vs gate-source voltage**Figure 10. Normalized gate threshold voltage vs temperature****Figure 11. Normalized on resistance vs temperature**

3 Test circuits

Figure 12. Switching times test circuit for resistive load

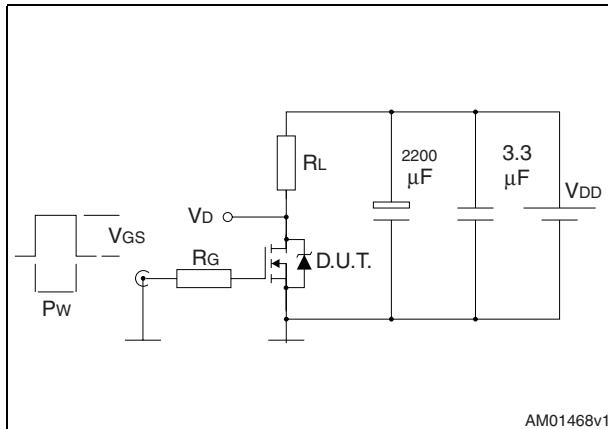


Figure 13. Gate charge test circuit

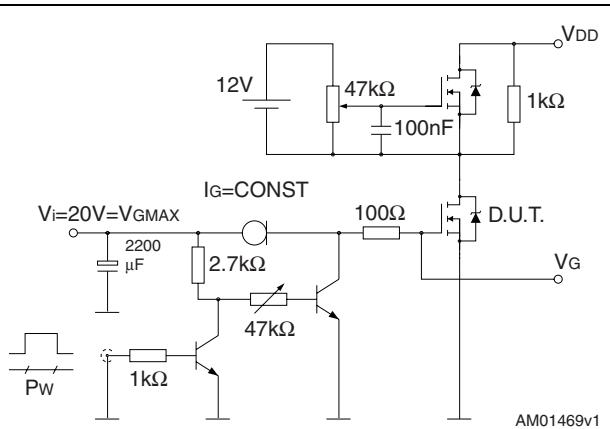


Figure 14. Test circuit for inductive load switching and diode recovery times

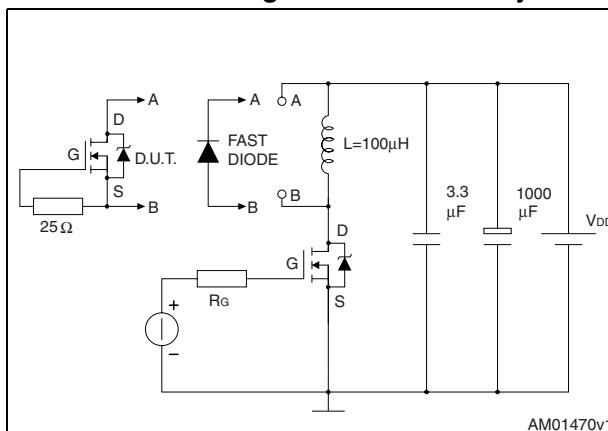


Figure 15. Unclamped inductive load test circuit

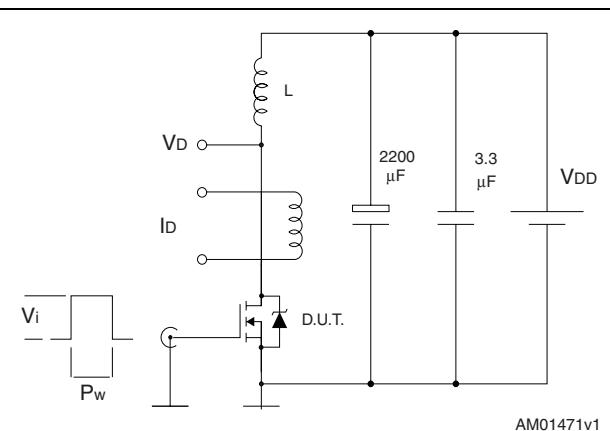


Figure 16. Unclamped inductive waveform

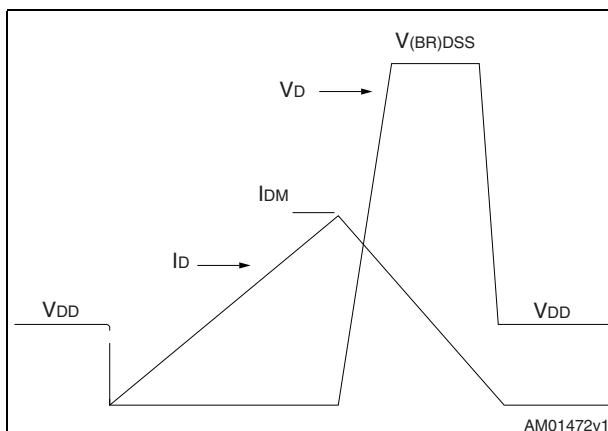


Figure 17. Switching time waveform

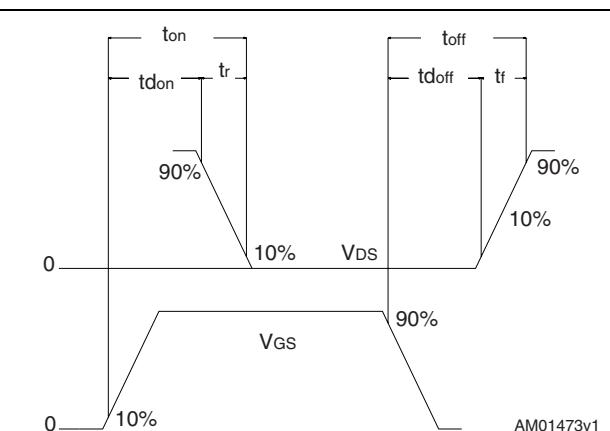
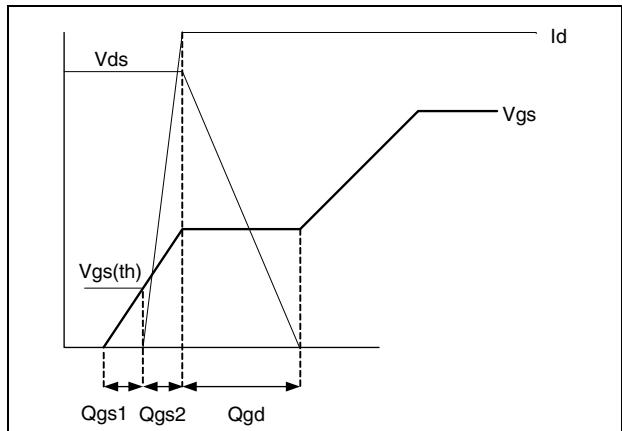


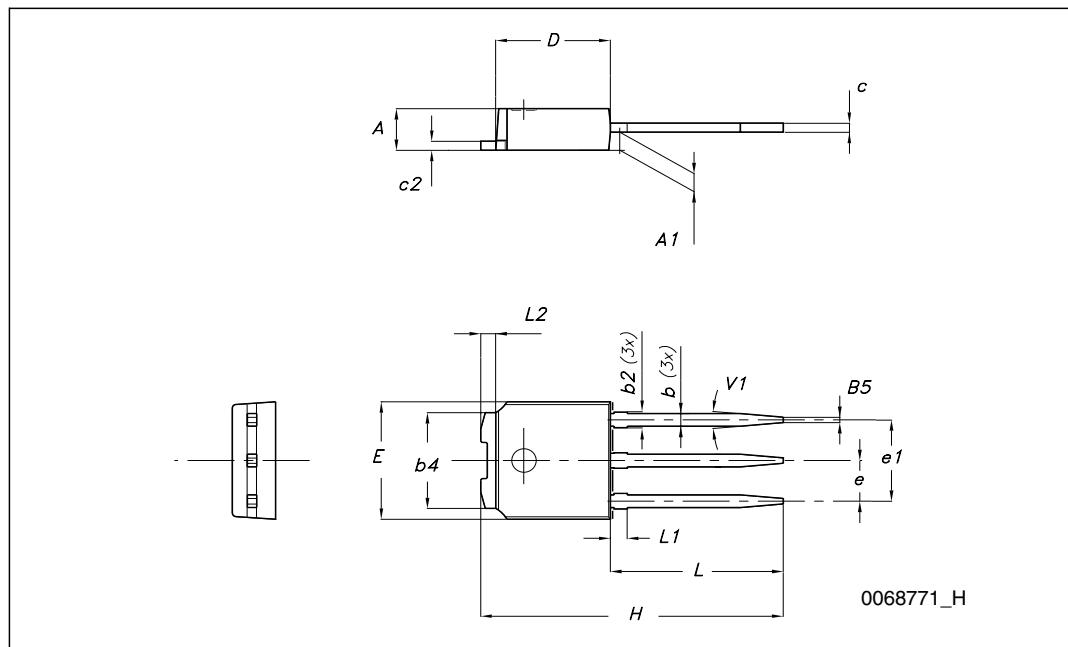
Figure 18. Gate charge waveform

4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com.
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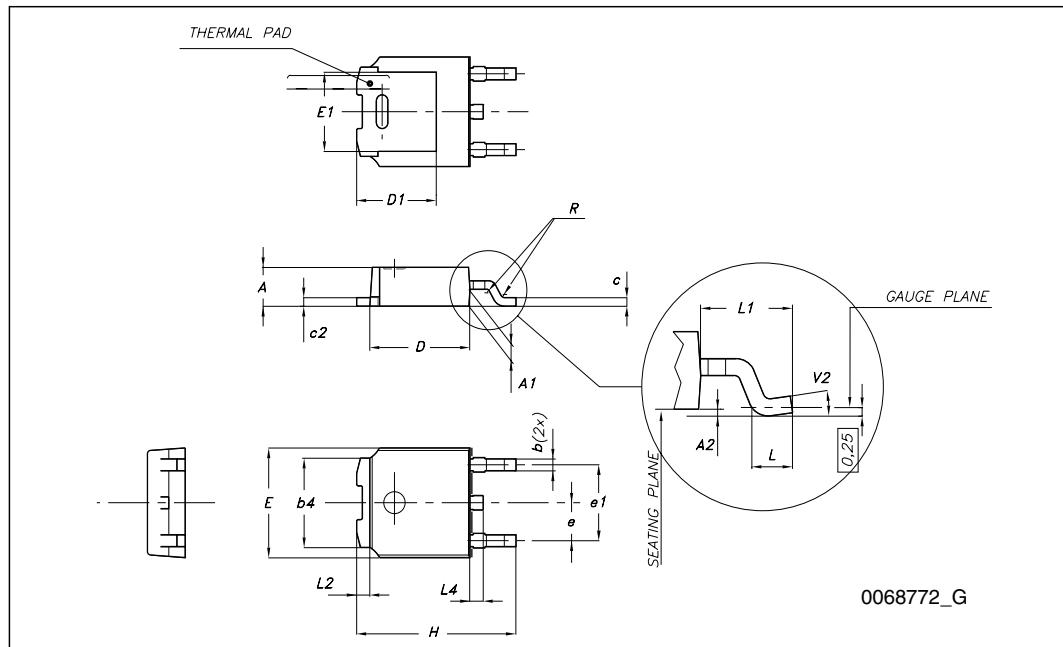
TO-251 (IPAK) mechanical data

DIM.	mm.		
	min.	typ	max.
A	2.20		2.40
A1	0.90		1.10
b	0.64		0.90
b2			0.95
b4	5.20		5.40
c	0.45		0.60
c2	0.48		0.60
D	6.00		6.20
E	6.40		6.60
e		2.28	
e1	4.40		4.60
H		16.10	
L	9.00		9.40
(L1)	0.80		1.20
L2		0.80	
V1		10°	



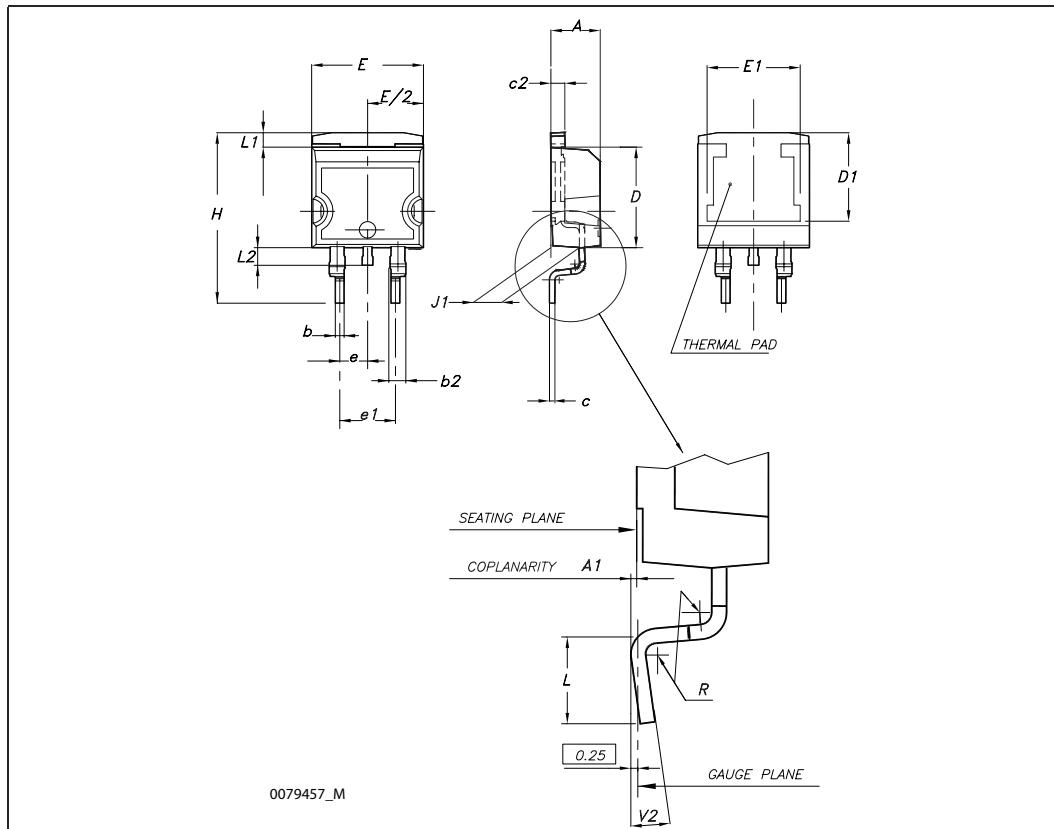
TO-252 (DPAK) mechanical data

DIM.	mm.		
	min.	typ	max.
A	2.20		2.40
A1	0.90		1.10
A2	0.03		0.23
b	0.64		0.90
b4	5.20		5.40
c	0.45		0.60
c2	0.48		0.60
D	6.00		6.20
D1		5.10	
E	6.40		6.60
E1		4.70	
e		2.28	
e1	4.40		4.60
H	9.35		10.10
L	1		
L1		2.80	
L2		0.80	
L4	0.60		1
R		0.20	
V2	0°		8°



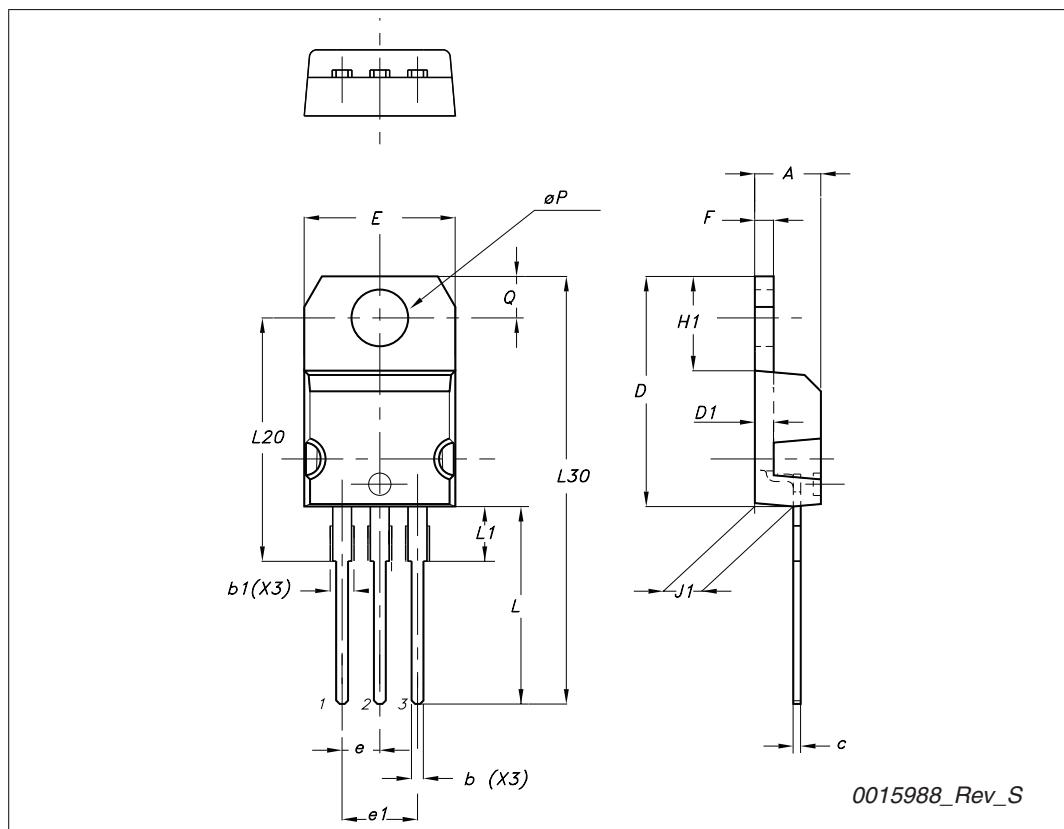
D²PAK (TO-263) mechanical data

Dim	mm			inch		
	Min	Typ	Max	Min	Typ	Max
A	4.40		4.60	0.173		0.181
A1	0.03		0.23	0.001		0.009
b	0.70		0.93	0.027		0.037
b2	1.14		1.70	0.045		0.067
c	0.45		0.60	0.017		0.024
c2	1.23		1.36	0.048		0.053
D	8.95		9.35	0.352		0.368
D1	7.50			0.295		
E	10		10.40	0.394		0.409
E1	8.50			0.334		
e		2.54			0.1	
e1	4.88		5.28	0.192		0.208
H	15		15.85	0.590		0.624
J1	2.49		2.69	0.099		0.106
L	2.29		2.79	0.090		0.110
L1	1.27		1.40	0.05		0.055
L2	1.30		1.75	0.051		0.069
R		0.4			0.016	
V2	0°		8°	0°		8°



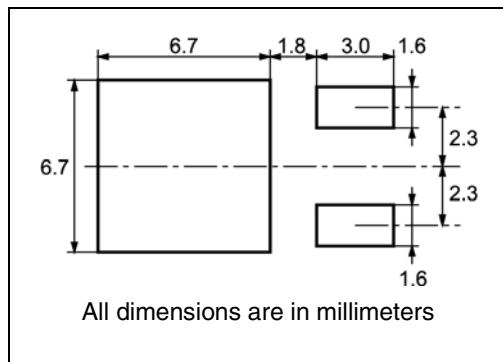
TO-220 type A mechanical data

Dim	mm		
	Min	Typ	Max
A	4.40		4.60
b	0.61		0.88
b1	1.14		1.70
c	0.48		0.70
D	15.25		15.75
D1		1.27	
E	10		10.40
e	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13		14
L1	3.50		3.93
L20		16.40	
L30		28.90	
$\emptyset P$	3.75		3.85
Q	2.65		2.95



5 Packaging mechanical data

DPAK FOOTPRINT

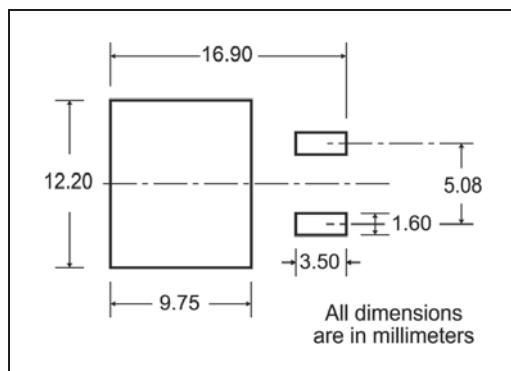


TAPE AND REEL SHIPMENT

REEL MECHANICAL DATA				
DIM.	mm		inch	
	MIN.	MAX.	MIN.	MAX.
A		330		12.992
B	1.5		0.059	
C	12.8	13.2	0.504	0.520
D	20.2		0.795	
G	16.4	18.4	0.645	0.724
N	50		1.968	
T		22.4		0.881

BASE QTY		BULK QTY	
2500		2500	

DIM.	mm		inch	
	MIN.	MAX.	MIN.	MAX.
A0	6.8	7	0.267	0.275
B0	10.4	10.6	0.409	0.417
B1		12.1		0.476
D	1.5	1.6	0.059	0.063
D1	1.5		0.059	
E	1.65	1.85	0.065	0.073
F	7.4	7.6	0.291	0.299
K0	2.55	2.75	0.100	0.108
P0	3.9	4.1	0.153	0.161
P1	7.9	8.1	0.311	0.319
P2	1.9	2.1	0.075	0.082
R	40		1.574	
W	15.7	16.3	0.618	0.641

D²PAK FOOTPRINT

TAPE AND REEL SHIPMENT

REEL MECHANICAL DATA			
DIM.	mm	inch	
	MIN.	MAX.	
A		330	12.992
B	1.5		0.059
C	12.8	13.2	0.504
D	20.2		0.795
G	24.4	26.4	0.960
N	100		3.937
T		30.4	1.197

BASE QTY	BULK QTY
1000	1000

TAPE MECHANICAL DATA

DIM.	mm	inch		
	MIN.	MAX.	MIN.	MAX.
A0	10.5	10.7	0.413	0.421
B0	15.7	15.9	0.618	0.626
D	1.5	1.6	0.059	0.063
D1	1.59	1.61	0.062	0.063
E	1.65	1.85	0.065	0.073
F	11.4	11.6	0.449	0.456
K0	4.8	5.0	0.189	0.197
P0	3.9	4.1	0.153	0.161
P1	11.9	12.1	0.468	0.476
P2	1.9	2.1	0.075	0.082
R	50		1.574	
T	0.25	0.35	0.0098	0.0137
W	23.7	24.3	0.933	0.956

10 pitches cumulative tolerance on tape + / - 0.2 mm

Center line of cavity

User Direction of Feed

TRL

FEED DIRECTION →

Bending radius R min.

6 Revision history

Table 8. Document revision history

Date	Revision	Changes
01-Dec-2008	1	First release
20-May-2009	2	<ul style="list-style-type: none">– Document status promoted from preliminary data to datasheet.– Added new package, mechanical data: D²PAK
10-Nov-2009	3	Added new device in TO-220

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